

SCOPE OF ACCREDITATION

Chemical Processing

Akron Plating Co Inc
1774 Hackberry St
Akron, OH 44301-2403

This certificate expiration is updated based on periodic audits. The current expiration date and scope of accreditation are listed at: www.eAuditNet.com - Online QML (Qualified Manufacturer Listing).

In recognition of the successful completion of the PRI evaluation process, accreditation is granted to this facility to perform the following:

AC7108 Rev I - Nadcap Audit Criteria for Chemical Processing (to be used on audits on/after 21 January 2018)

AC7108/04 – Solution Analysis and Testing – AC7108/4 must also be selected

AC7108/09 – Electroplating and Electroforming – AC7108/9 must also be selected

Ovens for Thermal Treatments with a set point at or below 250°F (121°C) or for Miscellaneous Heating Processes, e.g. Part Drying.

AC7108/4 Rev C - Nadcap Audit Criteria for Solution Analysis and Testing in Support of Chemical Processing to AC7108 (To Be Used On Audits Conducted On audits on/after 21 January 2018)

Testing Performed Internally In Support of the Chemical Process Accreditation

B11 – Adhesion Testing (Scratch and Chisel Test) In Support of AC7108

B16 – Coating Thickness Measurement In Support of AC7108

AC7108/9 - Nadcap Audit Criteria for Electroplating and Electroforming (to be used on audits on/after 5 June 2016)

Electroplating

Copper Plating